74LVC16245A-Q100; 74LVCH16245A-Q100 16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Rev. 1 — 20 November 2012

Product data sheet

General description 1.

The 74LVC16245A-Q100; 74LVCH16245A-Q100 are 16-bit transceivers featuring non-inverting 3-state bus compatible outputs in both send and receive directions. The device features two output-enable (nOE) inputs for easy cascading and two send/receive (nDIR) inputs for direction control. nOE controls the outputs so that the buses are effectively isolated. This device can be used as two 8-bit transceivers or one 16-bit transceiver. Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16245A-Q100 bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

This product has been qualified to the Automotive Electronics Council (AEC) standard Q100 (Grade 1) and is suitable for use in automotive applications.

Features and benefits 2.

- Automotive product qualification in accordance with AEC-Q100 (Grade 1) Specified from –40 °C to +85 °C and from –40 °C to +125 °C
- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- MULTIBYTE flow-through standard pinout architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- All data inputs have bus hold (74LVCH16245A-Q100 only)
- Complies with JEDEC standard:
 - JESD8-7A (1.65 V to 1.95 V)
 - JESD8-5A (2.3 V to 2.7 V)
 - JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - MIL-STD-883, method 3015 exceeds 2000 V
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-A exceeds 200 V (C = 200 pF, R = 0 Ω)



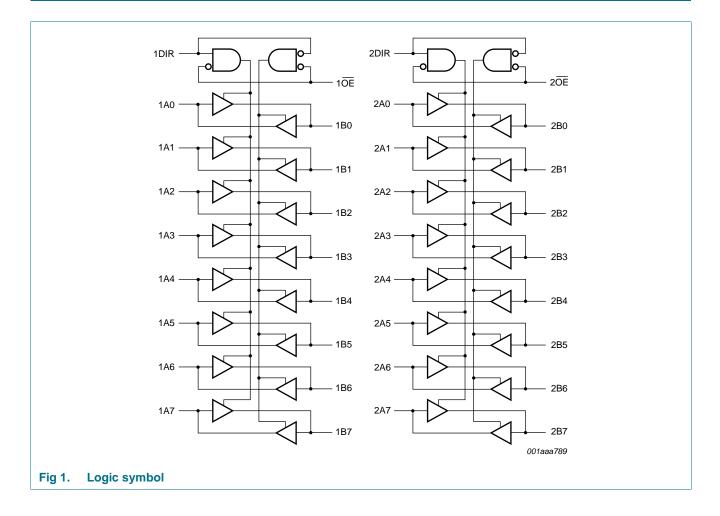
16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

3. Ordering information

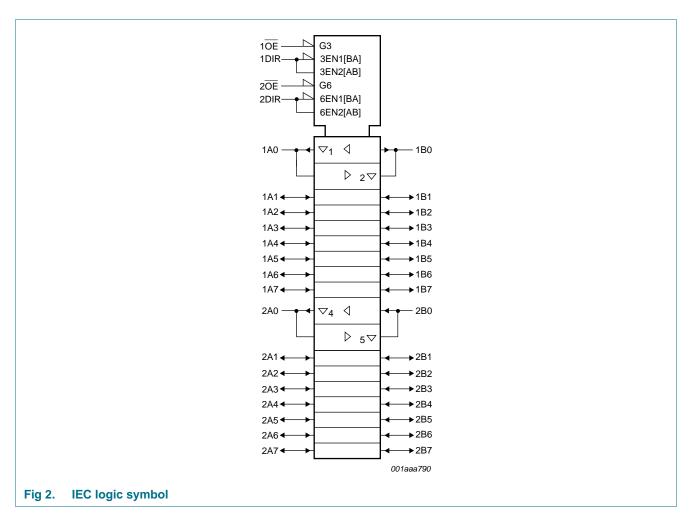
Table 1. Ordering information

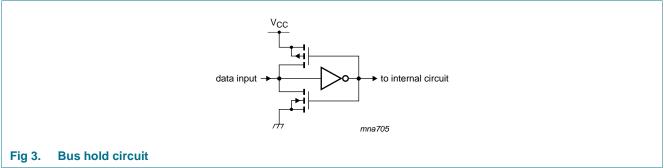
Type number	Temperature range	Package						
		Name	Description	Version				
74LVC16245ADGG-Q100	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1				
74LVCH16245ADGG-Q100			48 leads; body width 6.1 mm					
74LVC16245AEV-Q100	–40 °C to +125 °C	VFBGA56	plastic very thin fine-pitch ball grid array	SOT702-1				
74LVCH16245AEV-Q100			package; 56 balls; body $4.5 \times 7 \times 0.65$ mm					

4. Functional diagram



16-bit bus transceiver with direction pin; 5 V tolerant; 3-state





16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

5. Pinning information

74LVC16245A-Q100 74LVCH16245A-Q100 1DIR 1 48 10E 1B0 2 47 1A0 1B1 3 46 1A1 GND 4 45 GND 1B2 5 44 1A2 1B3 6 43 1A3 42 V_{CC} V_{CC} 7 1B4 8 41 1A4 1B5 9 40 1A5 39 GND GND 10 1B6 11 38 1A6 1B7 12 37 1A7 74LVC16245A-Q100 2B0 13 36 2A0 ball A1 74LVCH16245A_Q100 35 2A1 2B1 14 index area GND 15 34 GND $1 \ 2 \ 3 \ 4 \ 5 \ 6$ 2B2 16 33 2A2 000000 A 2B3 17 32 2A3 000000 В 000000 С V_{CC} 18 31 V_{CC} D 000000 2B4 19 30 2A4 Е 00 00 2B5 20 29 2A5 F 00 00 28 GND G 000000 GND 21 Н 000000 2B6 22 27 2A6 000000 J 2B7 23 26 2A7 κ 000000 25 20E 2DIR 24 aaa-004972 aaa-005103 Transparent top view Fig 4. Pin configuration SOT362-1 (TSSOP48) Fig 5. Pin configuration SOT702-1 (VFBGA56)

5.1 Pinning

NXP Semiconductors 74LVC16245A-Q100; 74LVCH16245A-Q100

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Table 2. Pin description							
Symbol	Pin		Description				
	SOT362-1	SOT702-1	_				
1DIR, 2DIR	1, 24	A1, K1	direction control input				
1B0 to 1B7	2, 3, 5, 6, 8, 9, 11, 12	B2, B1, C2, C1, D2, D1, E2, E1	data input/output				
2B0 to 2B7	13, 14, 16, 17, 19, 20, 22, 23	F1, F2, G1, G2, H1, H2, J1, J2	data input/output				
GND	4, 10, 15, 21, 28, 34, 39, 45	B3, B4, D3, D4, G3, G4, J3, J4	ground (0 V)				
V _{CC}	7, 18, 31, 42	C3, C4, H3, H4	supply voltage				
1 <u>0E</u> , 2 <u>0E</u>	48, 25	A6, K6	output enable input (active LOW)				
1A0 to 1A7	47, 46, 44, 43, 41, 40, 38, 37	B5, B6, C5, C6, D5, D6, E5, E6	data input/output				
2A0 to 2A7	36, 35, 33, 32, 30, 29, 27, 26	F6, F5, G6, G5, H6, H5, J6, J5	data input/output				
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	not connected				

5.2 Pin description

6. Functional description

Table 3. Function table^[1]

Inputs nOE		Outputs		
OE nDIR		nAn	nBn	
L	L	nAn = nBn	inputs	
L	Н	inputs	nBn = nAn	
Н	Х	Z	Z	

[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

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7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_{O} > V_{CC}$ or $V_{O} < 0$ V	-	±50	mA
Vo	output voltage	output HIGH or LOW	[2] -0.5	V _{CC} + 0.5	V
		output 3-state	[2] -0.5	+6.5	V
lo	output current	$V_{O} = 0 V$ to V_{CC}	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		-65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 \ ^{\circ}C \ to \ +125 \ ^{\circ}C;$			
		TSSOP48 package	<u>[3]</u>	500	mW
		VFBGA56 package	[4] _	1000	mW

[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

[2] The output voltage ratings may be exceeded if the output current ratings are observed.

[3] Above 60 °C, the value of P_{tot} derates linearly with 5.5 mW/K.

[4] Above 70 °C, the value of P_{tot} derates linearly with 1.8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

	.					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
VI	input voltage		0	-	5.5	V
Vo	output voltage	output HIGH or LOW	0	-	V _{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	V_{CC} = 1.2 V to 2.7 V	0	-	20	ns/V
		V_{CC} = 2.7 V to 3.6 V	0	-	10	ns/V

74LVC_LVCH16245A_Q100
Product data sheet

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9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	–40 °C to	o +125 °C	Uni
			Min	Typ[1]	Max	Min	Max	
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V
	voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V
		V_{CC} = 2.3 V to 2.7 V	1.7	-	-	1.7	-	V
		V_{CC} = 2.7 V to 3.6 V	2.0	-	-	2.0	-	V
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V
	voltage	V_{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V
		V_{CC} = 2.3 V to 2.7 V	-	-	0.7	-	0.7	V
		V_{CC} = 2.7 V to 3.6 V	-	-	0.8	-	0.8	V
V _{OH}	HIGH-level	$V_{I} = V_{IH} \text{ or } V_{IL}$						
	output voltage	$I_{O} = -100 \ \mu\text{A};$ $V_{CC} = 1.65 \ \text{V} \text{ to } 3.6 \ \text{V}$	$V_{CC}-0.2$	-	-	$V_{CC}-0.3$	-	V
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V
		$I_0 = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V
		$I_0 = -24$ mA; $V_{CC} = 3.0$ V	2.2	-	-	2.0	-	V
V _{OL}	LOW-level output	$V_{I} = V_{IH} \text{ or } V_{IL}$					Max - - 0.12 0.35 × V _{CC} 0.7 0.8 - <td></td>	
	voltage	I _O = 100 μA; V _{CC} = 1.65 V to 3.6 V	-	-	0.2	-	0.3	V
		$I_0 = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V
		$I_0 = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	0.8	V
		I_0 = 12 mA; V_{CC} = 2.7 V	-	-	0.4	-	0.6	V
		$I_0 = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V
I	input leakage current ^[2]	$V_1 = 5.5 V \text{ or GND};$ $V_{CC} = 3.6 V$	-	±0.1	±5	-	±20	μA
OZ	OFF-state output current ^{[2][3]}	$V_{I} = V_{IH} \text{ or } V_{IL};$ $V_{O} = 5.5 \text{ V or GND};$ $V_{CC} = 3.6 \text{ V}$	-	±0.1	±5	-	±20	μA
OFF	power-off leakage current	$V_{\text{I}} \text{ or } V_{\text{O}} = 5.5 \text{ V}; V_{\text{CC}} = 0.0 \text{ V}$	-	±0.1	±10	-	±20	μA
СС	supply current		-	0.1	20	-	80	μA
VICC	additional supply current	per input pin; V_I = V_{CC} - 0.6 V; I_O = 0 A; V_{CC} = 2.7 V to 3.6 V	-	5	500	-	5000	μA
Ci	input capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ V _I = GND to V _{CC}	-	5.0	-	-	-	pF
C _{I/O}	input/output capacitance	$V_{CC} = 0 V \text{ to } 3.6 V;$ $V_I = GND \text{ to } V_{CC}$	-	10	-	-	-	pF

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions	-40) °C to +85	5 °C	–40 °C to	o +125 ℃	Unit
			Min	Typ <mark>[1]</mark>	Max	Min	Max	
I _{BHL}	bus hold LOW	$V_{CC} = 1.65; V_I = 0.58 V$	10	-	-	10	-	μA
	current [4][5]	$V_{CC} = 2.3; V_I = 0.7 V$	30	-	-	25	-	μΑ
		$V_{CC} = 3.0; V_I = 0.8 V$	75	-	-	60	-	μΑ
I _{BHH}	bus hold HIGH	$V_{CC} = 1.65; V_I = 1.07 V$	-10	-	-	-10	-	μΑ
	current [4][5]	V _{CC} = 2.3; V _I = 1.7 V	-30	-	-	-25	-	μΑ
		$V_{CC} = 3.0; V_{I} = 2.0 V$	-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V	200	-	-	200	-	μΑ
	overdrive current	V _{CC} = 2.7 V	300	-	-	300	-	μΑ
	<u>(-)(-)</u>	V _{CC} = 3.6 V	500	-	-	500	-	μΑ
I _{BHHO}	bus hold HIGH	V _{CC} = 1.95 V	-200	-	-	-200	-	μΑ
	overdrive current	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
	<u>1.31-1</u>	V _{CC} = 3.6 V	-500	-	-	-500	-	μA

Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

[1] All typical values are measured at V_{CC} = 3.3 V (unless stated otherwise) and T_{amb} = 25 °C.

[2] The bus hold circuit is switched off when $V_I > V_{CC}$ allowing 5.5 V on the input terminal.

For I/O ports, the parameter I_{OZ} includes the input leakage current. [3]

[4] Valid for data inputs of bus hold parts only (74LVCH16245A-Q100). Note that control inputs do not have a bus hold circuit.

The specified sustaining current at the data input holds the input below the specified V_I level. [5]

The specified overdrive current at the data input forces the data input to the opposite input state. [6]

10. Dynamic characteristics

Dynamic characteristics Table 7.

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

Symbol	Parameter	Conditions	-40	°C to +8	5 °C	-40 °C to	o +125 °C	Unit
			Min	Typ ^[2]	Max	Min	Max	
t _{pd}	propagation	nAn to nBn; nBn to nAn; see Figure 6						
	delay	V _{CC} = 1.2 V	-	13.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.5	5.2	12.2	1.5	13.8	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	2.8	6.0	1.0	6.7	ns
		$V_{CC} = 2.7 V$	1.0	2.7	4.7	1.0	6.0	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.4	4.5	1.0	6.0	ns
t _{en}	enable time	nOE to nAn, nBn; see Figure 7 [1]						
		V _{CC} = 1.2 V	-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V} \text{ to } 1.95 \text{ V}$	1.5	5.9	15.0	1.5	16.9	ns
		V_{CC} = 2.3 V to 2.7 V	1.0	3.3	7.9	1.0	8.8	ns
		$V_{CC} = 2.7 V$	1.5	3.5	6.7	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$	1.0	2.7	5.5	1.0	7.0	ns

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	–40 °C to	o +125 ℃	Unit
				Min	Typ ^[2]	Max	Min	Max	
t _{dis}	disable time	nOE to nAn, nBn; see Figure 7	<u>[1]</u>						
		$V_{CC} = 1.2 V$		-	11.0	-	-	-	ns
		V_{CC} = 1.65 V to 1.95 V		1.0	4.9	13.1	1.0	14.7	ns
		V_{CC} = 2.3 V to 2.7 V		0.5	2.7	7.1	0.5	7.9	ns
		$V_{CC} = 2.7 V$		1.5	3.4	6.6	1.5	8.5	ns
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		1.5	3.3	5.6	1.5	7.0	ns
C _{PD}	power	per input; $V_I = GND$ to V_{CC}	[3]						
	dissipation capacitance	V_{CC} = 1.65 V to 1.95 V		-	11.5	-	-	-	pF
	capacitance	V_{CC} = 2.3 V to 2.7 V		-	15.2	-	-	-	pF
		$V_{CC} = 3.0 \text{ V} \text{ to } 3.6 \text{ V}$		-	18.5	-	-	-	pF

Table 7. Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 8.

[2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.

[3] C_{PD} is used to determine the dynamic power dissipation (P_D in μ W).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

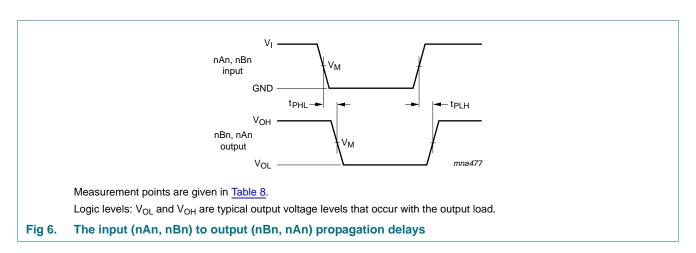
 C_{L} = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

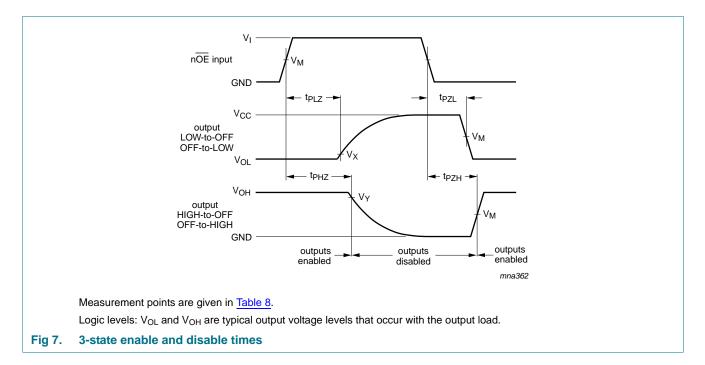


Table 8.Measurement points

Supply voltage	V _M	Input	Input						
V _{cc}		VI	$t_r = t_f$	V _X	V _Y				
1.2 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$				
1.65 V to 1.95 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$				
2.3 V to 2.7 V	$0.5\times V_{CC}$	V _{CC}	\leq 2.5 ns	V _{OL} + 0.15 V	$V_{OH} - 0.15 \ V$				
2.7 V	1.5 V	2.7 V	\leq 2.5 ns	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$				
3.0 V to 3.6 V	1.5 V	2.7 V	\leq 2.5 ns	V _{OL} + 0.3 V	$V_{OH} - 0.3 \ V$				

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

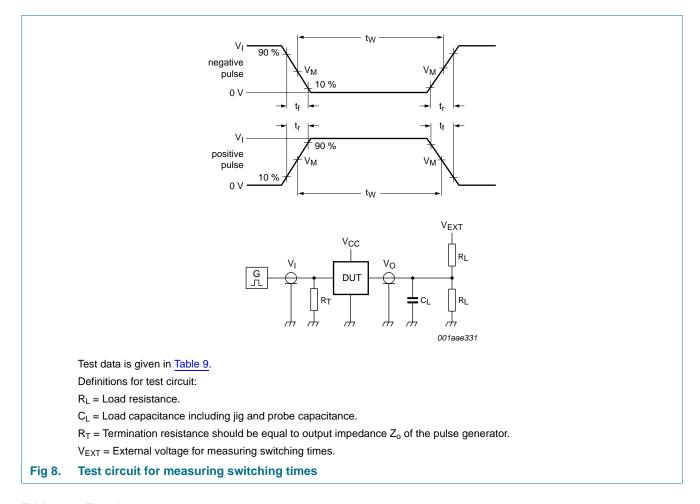


Table	9.	Test	data	

Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	C _L R _L t _P		t _{PLZ} , t _{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2 \times V_{CC}$	GND	
1.65 V to 1.95 V	V _{CC}	\leq 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V _{CC}	\leq 2 ns	30 pF	500 Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	\leq 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

NXP Semiconductors

74LVC16245A-Q100; 74LVCH16245A-Q100

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

12. Package outline

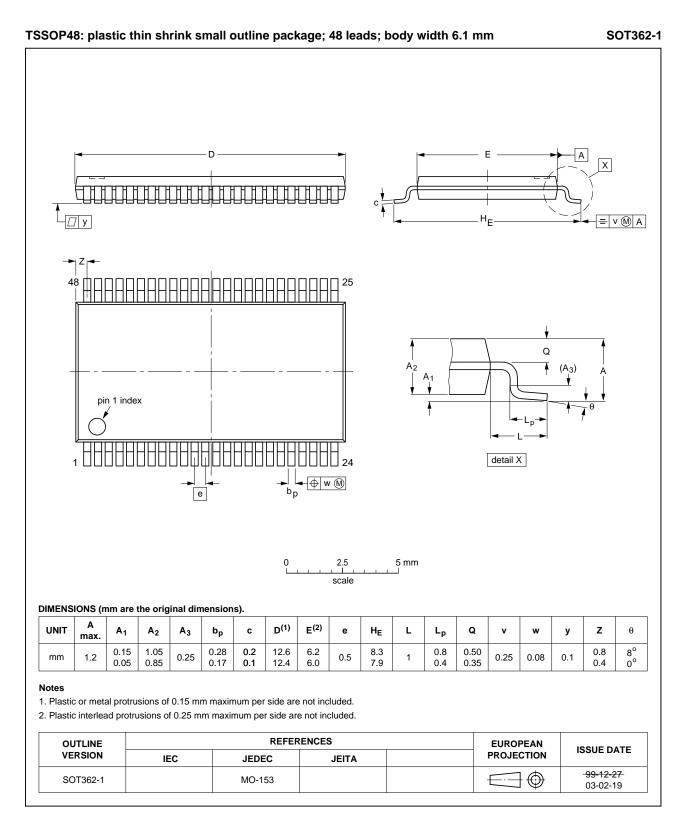


Fig 9. Package outline SOT362-1 (TSSOP48)

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16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

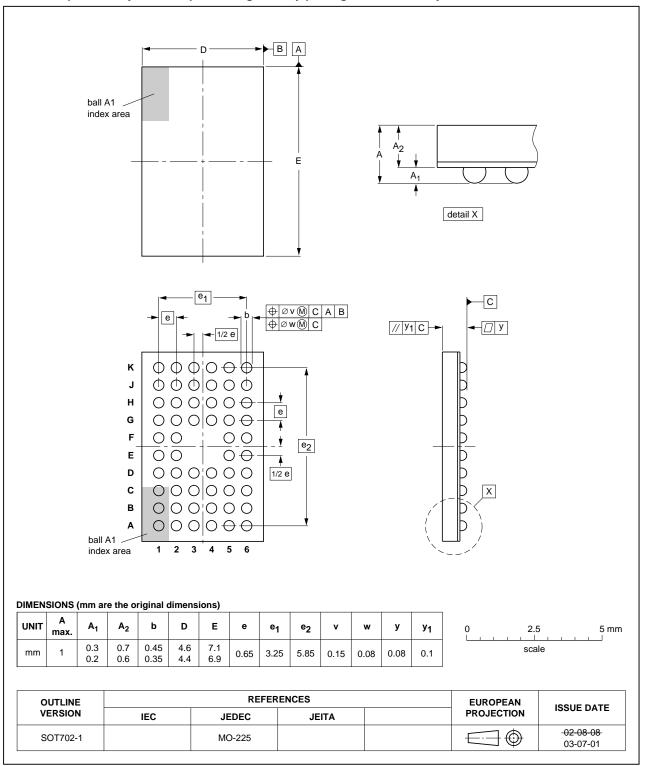




Fig 10. Package outline SOT702-1 (VFBGA56)

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16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

13. Abbreviations

Table 10.	Abbreviations	
Acronym	Description	
CDM	Charged Device Model	
DUT	Device Under Test	
ESD	ElectroStatic Discharge	
HBM	Human Body Model	
MM	Machine Model	
TTL	Transistor-Transistor Logic	
MIL	Military	

14. Revision history

Table 11. Revision history	Revision history						
Document ID	Release date	Data sheet status	Change notice	Supersedes			
74LVC_LVCH16245A_Q100 v.1	20121120	Product data sheet	-	-			

16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

15. Legal information

15.1 Data sheet status

Document status[1][2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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16-bit bus transceiver with direction pin; 5 V tolerant; 3-state

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Date of release: 20 November 2012 Document identifier: 74LVC_LVCH16245A_Q100